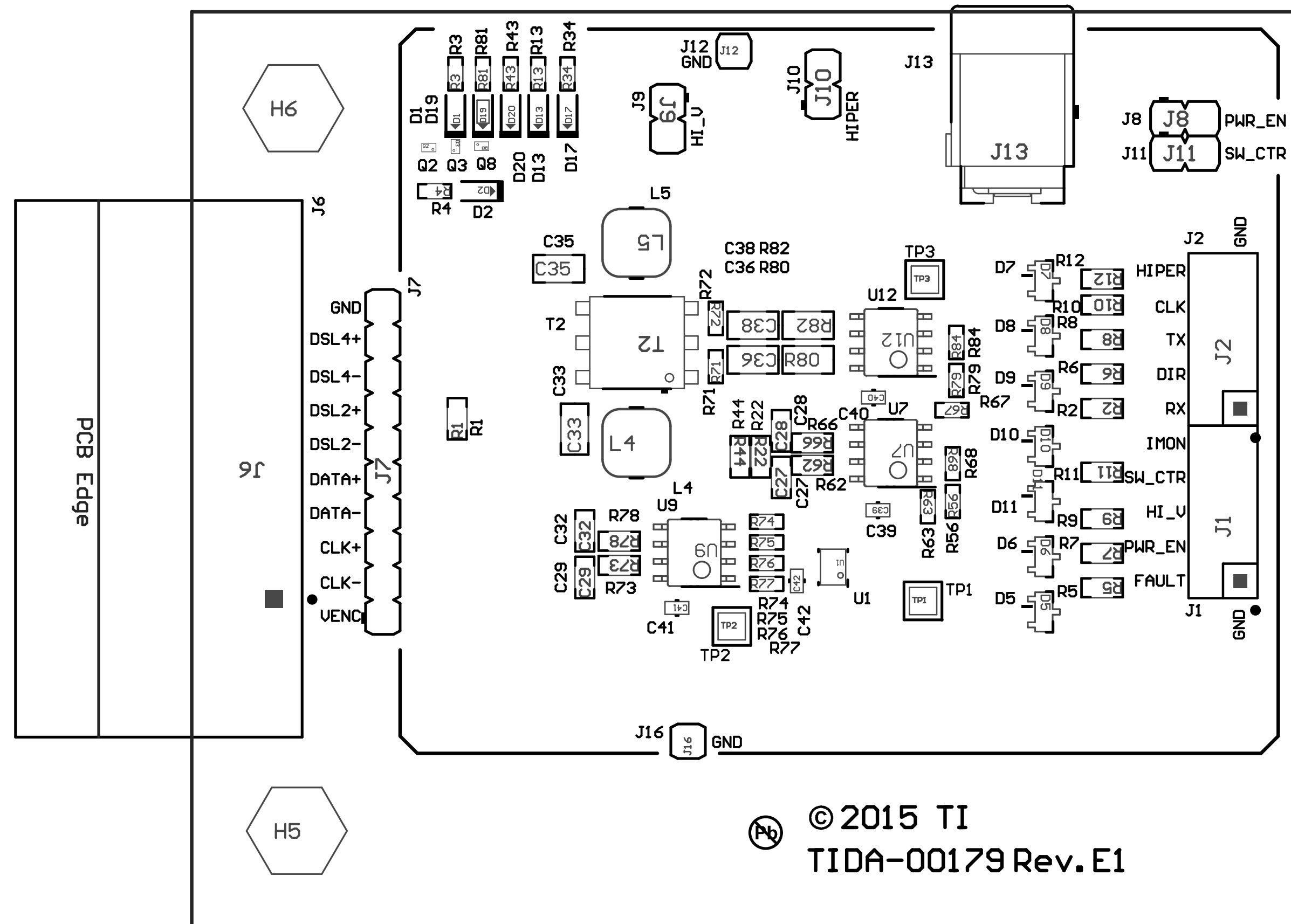


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: Production

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00179	REV: E1	SVN REV: Not In VersionControl
Top Layer Assembly Drawing			
PLOT NAME = Top Layer Assembly Drawing	GENERATED : 9/25/2015 10:28:13 AM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: Production

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00179	REV: E1	SUN REV: Not In VersionControl
			Bottom Layer Assembly
PLOT NAME = Bottom Layer Assembly Drawing	GENERATED	: 9/25/2015 10:28:14 AM	TEXAS INSTRUMENTS

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